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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10007754	FILING DATE 11/15/2001	CLASS 526	SUBCLASS 197	GAH 2812	EXAMINER FAYY MANDALIA
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**APPLICANTS: Hill Darrell; Sadaka Mariam; Abrokwhah Jonathan;

JC 3
JC 895

**CONTINUING DATA VERIFIED:

THIS APPLICATION IS A DIV OF 09/641,002 08/17/2000

LATT N 438

281L

**FOREIGN APPLICATIONS VERIFIED:

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>	
Foreign priority claimed 35 USC 119 conditions met		<input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO
Verified and Acknowledged Examiner's initials			SCI10776P D01
TITLE : Method of manufacturing a semiconductor component and semiconductor component thereof U.S. DEPT. OF COMM. PAT. & T. OFF. 10-94			

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING		
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.	Print Fig.
		Primary Examiner		
		PREPARED FOR ISSUE Application Examiner		
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